Due: Friday, March 21, 2003

- 1. A  $n^+$ -p Si junction with a long p-region has the following properties:  $N_a$  =1.5x10<sup>16</sup>/cm<sup>3</sup>;  $\mu_n$  = 1020 cm<sup>2</sup>/V-s;  $\mu_p$  = 380 cm<sup>2</sup>/V-s;  $\tau_n$  =1  $\mu$ s. If we apply 0.7 V forward bias to the junction at 300 K, what is the electric field in the p-region far from the junction? Draw a band diagram in the p-region far from the junction assuming that the junction is at x=0 and the p-side is in x>0.
- 2. Consider the following Si p-n junctions operating at 300 K.
  - (a) Using Eq. (5-8), calculate the contact potential  $V_o$  for  $N_a = 5 \times 10^{14}$  and  $5 \times 10^{18}$ /cm $^3$ , with  $N_d = 10^{15}$ ,  $10^{17}$ ,  $10^{19}$ /cm $^3$  in each case and plot  $V_o$  vs.  $N_d$ .
  - (b) Plot the maximum electric field  $\boldsymbol{E_0}$  vs.  $N_d$  for the junctions described in (a).
  - (c) Plot the width of the depletion region W vs.  $N_d$  for the junctions described in (a).
  - (d) Given that  $N_a = 10^{14}$  (and repeat for  $10^{19}/\text{cm}^3$ ) and  $N_d = 10^{19}/\text{cm}^3$ , determine the reverse bias needed to yield a maximum electric field  $\mathbf{E_0}$  in the junction which exceeds  $5 \times 10^5$  V/cm. and what is the depletion width under the reverse biasing?
- 3. A  $p^+$ -n silicon diode ( $V_0 = 0.926$  volts) has a donor doping of  $10^{17}$ /cm<sup>3</sup> and an n-region width = 1  $\mu$ m. Assume that the diode has a uniform cross sectional area of 0.001 cm<sup>2</sup>. Refer to Fig. 5-22 for the following questions.
  - (a) Does it break down by avalanche or punchthrough? Determine the depletion capacitance when the breakdown happens.
  - (b) If the doping is only  $1x10^{16}$ /cm<sup>3</sup>, what is the minimum n-region width for punchthrough not to take place?